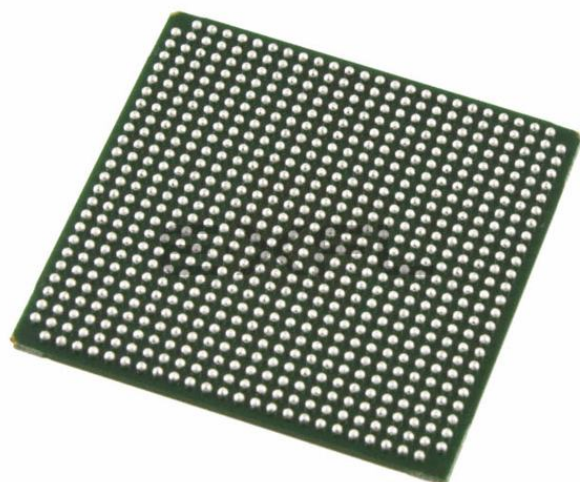




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

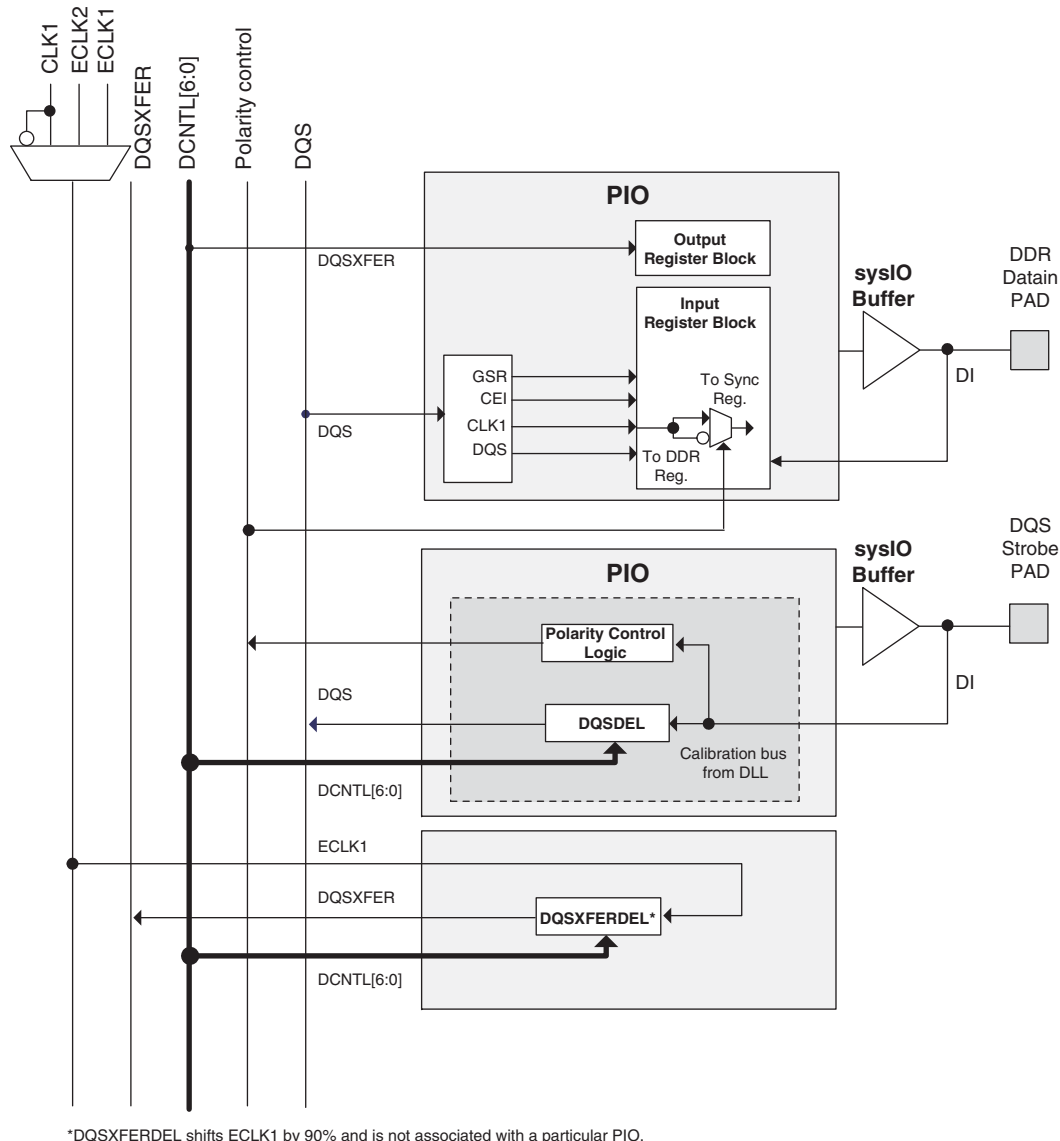
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	4000
Number of Logic Elements/Cells	32000
Total RAM Bits	339968
Number of I/O	450
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-35e-7f672c

Figure 2-36. DQS Local Bus



*DQSXFERDEL shifts ECLK1 by 90% and is not associated with a particular PIO.

Polarity Control Logic

In a typical DDR Memory interface design, the phase relationship between the incoming delayed DQS strobe and the internal system clock (during the READ cycle) is unknown.

The LatticeECP2/M family contains dedicated circuits to transfer data between these domains. To prevent set-up and hold violations, at the domain transfer between DQS (delayed) and the system clock, a clock polarity selector is used. This changes the edge on which the data is registered in the synchronizing registers in the input register block. This requires evaluation at the start of each READ cycle for the correct clock polarity.

Prior to the READ operation in DDR memories, DQS is in tristate (pulled by termination). The DDR memory device drives DQS low at the start of the preamble state. A dedicated circuit detects the first DQS rising edge after the preamble state. This signal is used to control the polarity of the clock to the synchronizing registers.

Symbol	Parameter	Min.	Max.	Units
V_{CCP}^6	PLL and Reference Clock Buffer Power	1.14	1.26	V

1. If V_{CCIO} or V_{CCJ} is set to 1.2V, they must be connected to the same power supply as V_{CC} . If V_{CCIO} or V_{CCJ} is set to 3.3V, they must be connected to the same power supply as V_{CCAUX} . V_{CCPLL} must be connected to the same power supply as V_{CC} through careful filtering and decoupling.
2. See recommended voltages by I/O standard in subsequent table.
3. V_{CCAUX} ramp rate must not exceed 30mV/ μ s during power-up when transitioning between 0V and 3.3V.
4. For proper power-up configuration, users must ensure that the configuration control signals such as the CFGx, INITN, PROGRAMN and DONE pins are driven to the proper logic levels when the device powers up. The device power-up is triggered by the last of V_{CC} , V_{CCAUX} or V_{CCIO8} supplies that reaches its minimum valid levels. Alternatively, if the configuration control signals are pulled up by V_{CCIO8} , the V_{CCIO8} (configuration I/O bank) voltage must be powered up prior to or at the same time as the last of V_{CC} or V_{CCAUX} reaches its minimum levels.
5. For power-up, V_{CC} must reach its valid minimum value before powering up V_{CCAUX} (LatticeECP2/M "S" version devices only).
6. V_{CCRX} , V_{CCTX} and V_{CCP} must be tied together in each quad and all quads need to be powered up.
7. For more power supply design recommendations, refer to TN1114 [Electrical Recommendations for Lattice SERDES](#).

Hot Socketing Specifications^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{DK}	Input or I/O leakage current	$0 \leq V_{IN} \leq V_{IH} \text{ (MAX.)}$	—	—	+/-1000	μ A
I_{HDIN}^5	SERDES average input current when device is powered down and inputs are driven		—	—	4	mA

1. V_{CC} , V_{CCAUX} and V_{CCIO} should rise/fall monotonically. V_{CC} and V_{CCPLL} must be connected to the same power supply (applies to ECP2-6, ECP2-12 and ECP2-20 only).
2. $0 \leq V_{CC} \leq V_{CC} \text{ (MAX.)}$, $0 \leq V_{CCIO} \leq V_{CCIO} \text{ (MAX.)}$ or $0 \leq V_{CCAUX} \leq V_{CCAUX} \text{ (MAX.)}$.
3. I_{DK} is additive to I_{PU} , I_{PW} or I_{BH} .
4. LVCMOS and LVTTL only.
5. Assumes that the device is powered down with all supplies grounded, both P and N inputs driven by a CML driver with maximum allowed V_{CCIB} of 1.575V, 8b10b data and internal AC coupling.

ESD Performance

Please refer to [LatticeECP2/M Product Family Qualification Summary](#) for complete qualification data, including ESD performance.

LVPECL

The LatticeECP2/M devices support the differential LVPECL standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The LVPECL input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

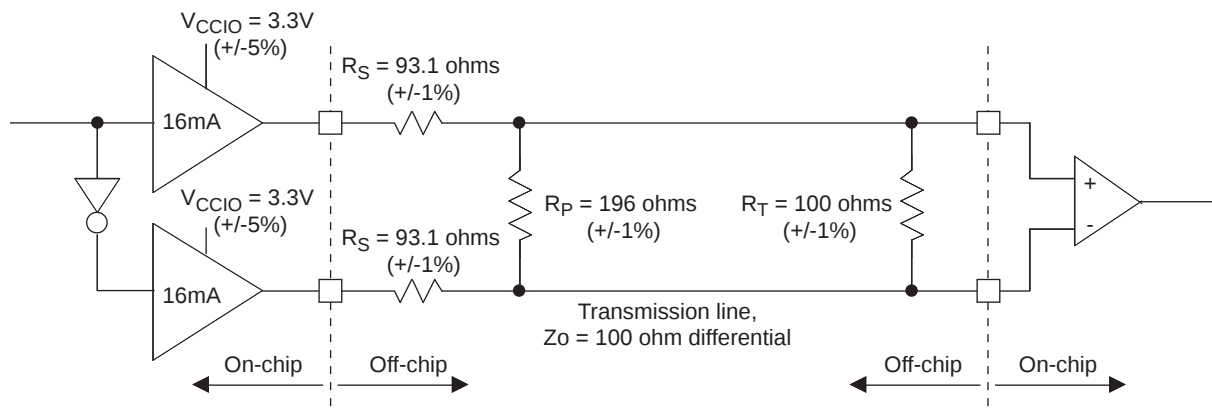


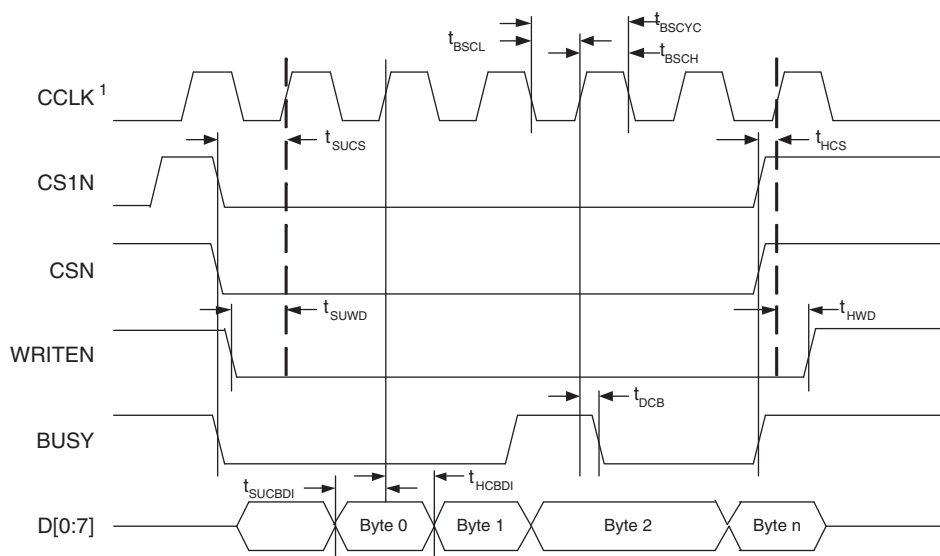
Table 3-4. LVPECL DC Conditions¹

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
V_{CCIO}	Output Driver Supply (+/-5%)	3.30	V
Z_{OUT}	Driver Impedance	10	Ω
R_S	Driver Series Resistor (+/-1%)	93	Ω
R_P	Driver Parallel Resistor (+/-1%)	196	Ω
R_T	Receiver Termination (+/-1%)	100	Ω
V_{OH}	Output High Voltage	2.05	V
V_{OL}	Output Low Voltage	1.25	V
V_{OD}	Output Differential Voltage	0.80	V
V_{CM}	Output Common Mode Voltage	1.65	V
Z_{BACK}	Back Impedance	100.5	Ω
I_{DC}	DC Output Current	12.11	mA

1. For input buffer, see LVDS table.

Figure 3-15. sysCONFIG Parallel Port Write Cycle



1. In Master Parallel Mode the FPGA provides CCLK. In Slave Parallel Mode the external device provides CCLK.

Figure 3-16. sysCONFIG Slave Serial Port Timing

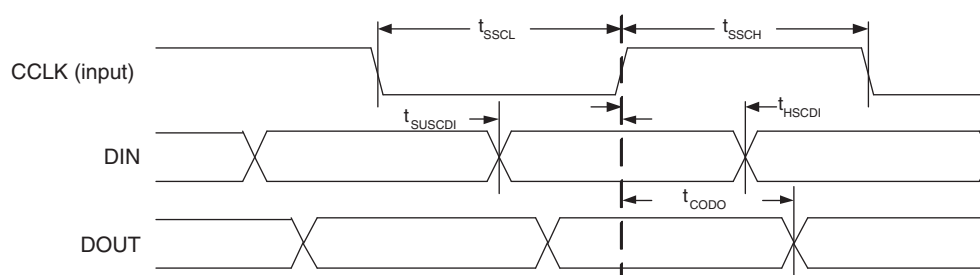
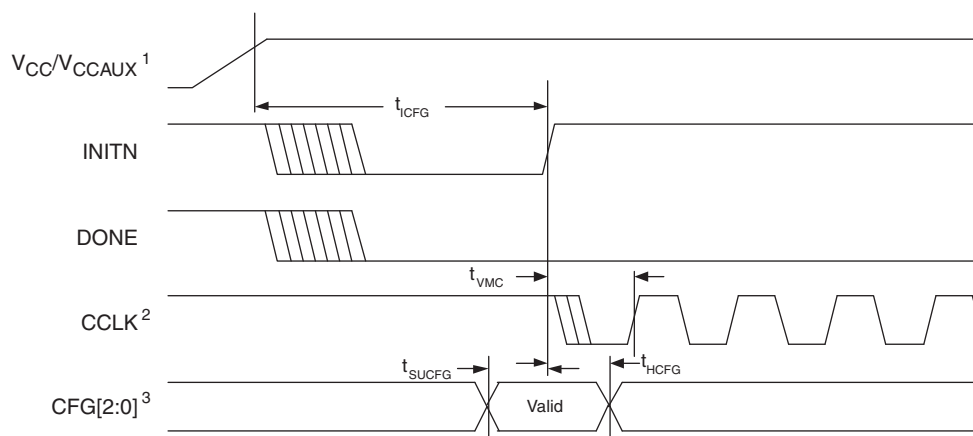


Figure 3-17. Power-On-Reset (POR) Timing



1. Time taken from V_{CC} or V_{CCAUX} , whichever is the last to reach its V_{MIN} .
2. Device is in a Master Mode.
3. The CFG pins are normally static (hard wired).

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or B (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pins, when not used as special purpose pins, can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration. See “Typical sysI/O I/O Behavior During Power-up” for more information about I/O behavior during power-up.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V _{CC}	—	Power supply pins for core logic. Dedicated pins.
V _{CCAUX}	—	Auxiliary power supply pin. This dedicated pin powers all the differential and referenced input buffers.
V _{CCIOx}	—	Dedicated power supply pins for I/O bank x.
V _{CCPLL}	—	PLL supply pins. Should be tied to V _{CC} even when the corresponding PLL is unused.
V _{REF1_x} , V _{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V _{REF} inputs. When not used, they may be used as I/O pins.
XRES ⁴	—	10K ohm +/-1% resistor must be connected between this pad and ground.
PLLCAP ⁴	—	External capacitor connection for PLL.
PLL, DLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_V _{CCPLL}	—	Power supply pin for PLL: LUM, LLM, RUM, RLM, num = row from center.
[LOC][num]_GPLL[T, C]_IN_A	I	General Purpose PLL (GPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_GPLL[T, C]_FB_A	I	Optional feedback GPLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_IN_A ⁵	I	Secondary PLL (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_FB_A ⁵	I	Optional feedback (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_IN_A	I	DLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_FB_A	I	Optional feedback (DLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]DQS[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQS, num = ball function number.
[LOC]DQ[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQ, associated DQS number.
Test and Programming (Dedicated Pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data Out pin used to shift data out of a device using 1149.1.
VCCJ	—	Power supply pin for JTAG Test Access Port.
Configuration Pads (Used During sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration mode values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI or SPI _m mode.
CSN	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (active low).
D[0]/SPIFASTN	I/O	sysCONFIG Port Data I/O for Parallel mode. sysCONFIG Port Data I/O for SPI or SPI _m . When using the SPI or SPI _m mode, this pin should either be tied high or low, must not be left floating.
D[1:6]	I/O	sysCONFIG Port Data I/O for Parallel
D[7]/SPID0	I/O	sysCONFIG Port Data I/O for Parallel, SPI, SPI _m
DOUT/CSO	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPI0N	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPI _m modes.
Dedicated SERDES Signals^{1, 2, 3}		
[LOC]_SQ_VCCAUX33	—	Termination resistor switching power (3.3V). This pin must be tied to 3.3V even if the quad is unused.
[LOC]_SQ_REFCLKN	I	Negative Reference Clock Input
[LOC]_SQ_REFCLKP	I	Positive Reference Clock Input
[LOC]_SQ_VCCP	—	PLL and Reference clock buffer power (1.2V). This pin must be tied to 1.2V even if the quad is unused.

PICs and DDR Data (DQ) Pins Associated with the DDR Strobe (DQS) Pin

PICs Associated with DQS Strobe	PIO Within PIC	DDR Strobe (DQS) and Data (DQ) Pins
For Left and Right Edges of the Device		
P[Edge] [n-4]	A	DQ
	B	DQ
P[Edge] [n-3]	A	DQ
	B	DQ
P[Edge] [n-2]	A	DQ
	B	DQ
P[Edge] [n-1]	A	DQ
	B	DQ
P[Edge] [n]	A	[Edge]DQSn
	B	DQ
P[Edge] [n+1]	A	DQ
	B	DQ
P[Edge] [n+2]	A	DQ
	B	DQ
P[Edge] [n+3]	A	DQ
	B	DQ
For Bottom Edge of the Device		
P[Edge] [n-4]	A	DQ
	B	DQ
P[Edge] [n-3]	A	DQ
	B	DQ
P[Edge] [n-2]	A	DQ
	B	DQ
P[Edge] [n-1]	A	DQ
	B	DQ
P[Edge] [n]	A	[Edge]DQSn
	B	DQ
P[Edge] [n+1]	A	DQ
	B	DQ
P[Edge] [n+2]	A	DQ
	B	DQ
P[Edge] [n+3]	A	DQ
	B	DQ
P[Edge] [n+4]	A	DQ
	B	DQ

Notes:

1. "n" is a row PIC number.
2. The DDR interface is designed for memories that support one DQS strobe up to 15 bits of data for the left and right edges and up to 17 bits of data for the bottom edge. In some packages, all the potential DDR data (DQ) pins may not be available. PIC numbering definitions are provided in the "Signal Names" column of the Signal Descriptions table.

LatticeECP2 Pin Information Summary, LFE2-50 and LFE2-70 (Cont.)

Pin Type		LFE2-50		LFE2-70	
		484 fpBGA	672 fpBGA	672 fpBGA	900 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0
	Bank1	0	0	0	0
	Bank2	2	3	3	4
	Bank3	0	3	3	3
	Bank4	3	4	4	4
	Bank5	3	4	4	5
	Bank6	1	4	4	4
	Bank7	2	3	3	4
	Bank8	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0
	Bank1	0	0	0	0
	Bank2	0	0	0	0
	Bank3	0	0	0	0
	Bank4	46	62	62	72
	Bank5	46	68	68	80
	Bank6	0	0	0	0
	Bank7	0	0	0	0
	Bank8	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35 (Cont.)

Pin Type		LFE2M20		LFE2M35		
		256 fpBGA	484 fpBGA	256 fpBGA	484 fpBGA	672 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0
	Bank1	0	0	0	0	0
	Bank2	0	1	0	1	3
	Bank3	0	1	0	1	2
	Bank4	2	4	2	4	3
	Bank5	1	2	1	2	3
	Bank6	0	3	0	1	2
	Bank7	1	2	1	2	3
	Bank8	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0
	Bank1	0	0	0	0	0
	Bank2	0	0	0	0	0
	Bank3	0	0	0	0	0
	Bank4	32	62	32	62	50
	Bank5	20	28	20	28	60
	Bank6	16	40	16	39	52
	Bank7	28	40	28	40	60
	Bank8	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 (Cont.)

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	2	2	2	4	4	4	4
	Bank3	2	1	1	3	4	3	5
	Bank4	3	1	3	3	3	3	3
	Bank5	2	3	3	2	3	2	3
	Bank6	1	2	2	3	4	3	5
	Bank7	3	3	3	4	4	4	5
	Bank8	0	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	0	0	0	0	72	0	80
	Bank3	0	0	0	0	64	0	80
	Bank4	50	24	48	48	40	48	44
	Bank5	60	60	50	40	40	40	46
	Bank6	52	54	60	62	66	62	82
	Bank7	60	60	68	70	74	70	90
	Bank8	0	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M8	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
GND	GNDIO5	-			GNDIO5	-		
P7	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
R8	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
VCCIO	VCCIO4	4			VCCIO4	4		
T5	PB14A	4	BDQ15	T	PB32A	4	BDQ33	T
T6	PB14B	4	BDQ15	C	PB32B	4	BDQ33	C
T8	PB15A	4	BDQS15	T	PB33A	4	BDQS33	T
GND	GNDIO4	-			GNDIO4	-		
R7	PB16A	4	BDQ15	T	PB34A	4	BDQ33	T
T9	PB15B	4	BDQ15	C	PB33B	4	BDQ33	C
T7	PB16B	4	BDQ15	C	PB34B	4	BDQ33	C
L8	PB17A	4	BDQ15	T	PB35A	4	BDQ33	T
VCCIO	VCCIO4	4			VCCIO4	4		
P8	PB18A	4	BDQ15	T	PB36A	4	BDQ33	T
L9	PB17B	4	BDQ15	C	PB35B	4	BDQ33	C
N8	PB18B	4	BDQ15	C	PB36B	4	BDQ33	C
R9	PB19A	4	BDQ15	T	PB37A	4	BDQ33	T
GND	GNDIO4	-			GNDIO4	-		
R10	PB19B	4	BDQ15	C	PB37B	4	BDQ33	C
-	-	-			VCCIO	4		
-	-	-			GNDIO4	4		
N9	PB20A	4	BDQ24	T	PB47A	4	BDQ51	T
T10	PB21A	4	BDQ24	T	PB48A	4	BDQ51	T
M9	PB20B	4	BDQ24	C	PB47B	4	BDQ51	C
R11	PB21B	4	BDQ24	C	PB48B	4	BDQ51	C
P10	PB22A	4	BDQ24	T	PB49A	4	BDQ51	T
N11	PB23A	4	BDQ24	T	PB50A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
N10	PB22B	4	BDQ24	C	PB49B	4	BDQ51	C
P11	PB23B	4	BDQ24	C	PB50B	4	BDQ51	C
T11	PB24A	4	BDQS24	T	PB51A	4	BDQS51	T
GND	GNDIO4	-			GNDIO4	-		
M11	PB25A	4	BDQ24	T	PB52A	4	BDQ51	T
T12	PB24B	4	BDQ24	C	PB51B	4	BDQ51	C
L11	PB25B	4	BDQ24	C	PB52B	4	BDQ51	C
T13	PB26A	4	BDQ24	T	PB53A	4	BDQ51	T
R13	PB27A	4	BDQ24	T	PB54A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
T14	PB26B	4	BDQ24	C	PB53B	4	BDQ51	C
P13	PB27B	4	BDQ24	C	PB54B	4	BDQ51	C
GND	GNDIO4	-			GNDIO4	-		
N12	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
M12	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
R15	CFG2	8			CFG2	8		

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
GND	GND	GNDIO5	-		
R4	R4	PB33A	5	BDQS33	T
L6	L6	PB34A	5	BDQ33	T
T4	T4	PB33B	5	BDQ33	C
L7	L7	PB34B	5	BDQ33	C
N7	N7	PB35A	5	PCLKT5_0/BDQ33	T
VCCIO	VCCIO	VCCIO5	5		
M8	M8	PB35B	5	PCLKC5_0/BDQ33	C
GND	GND	GNDIO5	-		
P7	P7	PB40A	4	PCLKT4_0/BDQ42	T
R8	R8	PB40B	4	PCLKC4_0/BDQ42	C
VCCIO	VCCIO	VCCIO4	4		
T5	T5	PB41A	4	BDQ42	T
T6	T6	PB41B	4	BDQ42	C
T8	T8	PB42A	4	BDQS42	T
GND	GND	GNDIO4	-		
R7	R7	PB43A	4	BDQ42	T
T9	T9	PB42B	4	BDQ42	C
T7	T7	PB43B	4	BDQ42	C
L8	L8	PB44A	4	BDQ42	T
VCCIO	VCCIO	VCCIO4	4		
P8	P8	PB45A	4	BDQ42	T
L9	L9	PB44B	4	BDQ42	C
N8	N8	PB45B	4	BDQ42	C
R9	R9	PB46A	4	BDQ42	T
GND	GND	GNDIO4	-		
R10	R10	PB46B	4	BDQ42	C
-	VCC	VCCIO	4		
-	GND	GNDIO4	4		
N9	N9	PB56A	4	BDQ60	T
T10	T10	PB57A	4	BDQ60	T
M9	M9	PB56B	4	BDQ60	C
R11	R11	PB57B	4	BDQ60	C
P10	P10	PB58A	4	BDQ60	T
N11	N11	PB59A	4	BDQ60	T
VCCIO	VCCIO	VCCIO4	4		
N10	N10	PB58B	4	BDQ60	C
P11	P11	PB59B	4	BDQ60	C
T11	T11	PB60A	4	BDQS60	T
GND	GND	GNDIO4	-		
M11	M11	PB61A	4	BDQ60	T
T12	T12	PB60B	4	BDQ60	C

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
A5	A5	PT36B	0		C
A3	A3	PT35B	0		C
A4	A4	PT36A	0		T
VCCIO	VCCIO	VCCIO0	0		
B3	B3	PT35A	0		T
A2	A2	PT34B	0		C
C7	C7	PT33B	0		C
B2	B2	PT34A	0		T
D7	D7	PT33A	0		T
D6	D6	PT32B	0		C
GND	GND	GNDIO0	-		
F7	F7	PT31B	0		C
C6	C6	PT32A	0		T
VCCIO	VCCIO	VCCIO0	0		
F6	F6	PT31A	0		T
C4	C4	PT30B	0		C
B4	B4	PT30A	0		T
-	GND	GNDIO0	0		
-	VCC	VCCIO	0		
D5	D5	PT2B	0	VREF2_0	C
E5	E5	PT2A	0	VREF1_0	T
G7	G7	VCC	-		
G9	G9	VCC	-		
H7	H7	VCC	-		
J10	J10	VCC	-		
K10	K10	VCC	-		
K8	K8	VCC	-		
G8	G8	VCCAUX	-		
H10	H10	VCCAUX	-		
J7	J7	VCCAUX	-		
K9	K9	VCCAUX	-		
C5	C5	VCCIO0	0		
E7	E7	VCCIO0	0		
C12	C12	VCCIO1	1		
E10	E10	VCCIO1	1		
E14	E14	VCCIO2	2		
G12	G12	VCCIO2	2		
K12	K12	VCCIO3	3		
M14	M14	VCCIO3	3		
M10	M10	VCCIO4	4		
P12	P12	VCCIO4	4		
M7	M7	VCCIO5	5		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GND	GNDIO5	-			GNDIO5	-			
W10	PB11A	5	BDQ15	T	PB11A	5	BDQ15	T	
Y10	PB11B	5	BDQ15	C	PB11B	5	BDQ15	C	
W11	PB12A	5	BDQ15	T	PB12A	5	BDQ15	T	
AA10	PB12B	5	BDQ15	C	PB12B	5	BDQ15	C	
AC8	PB13A	5	BDQ15	T	PB13A	5	BDQ15	T	
AD8	PB13B	5	BDQ15	C	PB13B	5	BDQ15	C	
VCCIO	VCCIO5	5			VCCIO5	5			
AB8	PB14A	5	BDQ15	T	PB14A	5	BDQ15	T	
AB10	PB14B	5	BDQ15	C	PB14B	5	BDQ15	C	
GND	GNDIO5	-			GNDIO5	-			
AE6	PB15A	5	BDQS15	T	PB15A	5	BDQS15	T	
AF6	PB15B	5	BDQ15	C	PB15B	5	BDQ15	C	
AA11	PB16A	5	BDQ15	T	PB16A	5	BDQ15	T	
AC9	PB16B	5	BDQ15	C	PB16B	5	BDQ15	C	
AB9	PB17A	5	BDQ15	T	PB17A	5	BDQ15	T	
AD9	PB17B	5	BDQ15	C	PB17B	5	BDQ15	C	
VCCIO	VCCIO5	5			VCCIO5	5			
Y11	PB18A	5	BDQ15	T	PB18A	5	BDQ15	T	
AB11	PB18B	5	BDQ15	C	PB18B	5	BDQ15	C	
AE7	PB19A	5	BDQ15	T	PB19A	5	BDQ15	T	
AF7	PB19B	5	BDQ15	C	PB19B	5	BDQ15	C	
GND	GNDIO5	-			GNDIO5	-			
AC10	PB20A	5	BDQ24	T	PB20A	5	BDQ24	T	
AD10	PB20B	5	BDQ24	C	PB20B	5	BDQ24	C	
AA12	PB21A	5	BDQ24	T	PB21A	5	BDQ24	T	
W12	PB21B	5	BDQ24	C	PB21B	5	BDQ24	C	
AB12	PB22A	5	BDQ24	T	PB22A	5	BDQ24	T	
VCCIO	VCCIO5	5			VCCIO5	5			
Y12	PB22B	5	BDQ24	C	PB22B	5	BDQ24	C	
AD12	PB23A	5	BDQ24	T	PB23A	5	BDQ24	T	
AC12	PB23B	5	BDQ24	C	PB23B	5	BDQ24	C	
AC13	PB24A	5	BDQS24	T	PB24A	5	BDQS24	T	
GND	GNDIO5	-			GNDIO5	-			
AA13	PB24B	5	BDQ24	C	PB24B	5	BDQ24	C	
AD13	PB25A	5	BDQ24	T	PB25A	5	BDQ24	T	
AC14	PB25B	5	BDQ24	C	PB25B	5	BDQ24	C	
AE8	PB26A	5	BDQ24	T	PB26A	5	BDQ24	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AF8	PB26B	5	BDQ24	C	PB26B	5	BDQ24	C	
AB15	PB27A	5	BDQ24	T	PB27A	5	BDQ24	T	
Y13	PB27B	5	BDQ24	C	PB27B	5	BDQ24	C	
AE9	PB28A	5	BDQ24	T	PB28A	5	BDQ24	T	
GND	GNDIO5	-			GNDIO5	-			
AF9	PB28B	5	BDQ24	C	PB28B	5	BDQ24	C	
W13	PB29A	5	BDQ33	T	PB29A	5	BDQ33	T	

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D4	PT7B	0		C	PT7B	0		C
D3	PT7A	0		T	PT7A	0		T
C2	PT6B	0		C	PT6B	0		C
C1	PT6A	0		T	PT6A	0		T
G8	PT5B	0		C	PT5B	0		C
GND	GNDIO0	-			GNDIO0	-		
G7	PT5A	0		T	PT5A	0		T
E7	PT4B	0		C	PT4B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
F7	PT4A	0		T	PT4A	0		T
E6	PT3B	0		C	PT3B	0		C
E5	PT3A	0		T	PT3A	0		T
G6	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
G5	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T
L12	VCC	-			VCC	-		
L13	VCC	-			VCC	-		
L14	VCC	-			VCC	-		
L15	VCC	-			VCC	-		
M11	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M15	VCC	-			VCC	-		
M16	VCC	-			VCC	-		
N11	VCC	-			VCC	-		
N16	VCC	-			VCC	-		
P11	VCC	-			VCC	-		
P16	VCC	-			VCC	-		
R11	VCC	-			VCC	-		
R12	VCC	-			VCC	-		
R15	VCC	-			VCC	-		
R16	VCC	-			VCC	-		
T12	VCC	-			VCC	-		
T13	VCC	-			VCC	-		
T14	VCC	-			VCC	-		
T15	VCC	-			VCC	-		
D11	VCCIO0	0			VCCIO0	0		
D6	VCCIO0	0			VCCIO0	0		
G9	VCCIO0	0			VCCIO0	0		
K12	VCCIO0	0			VCCIO0	0		
J12	VCCIO0	0			VCCIO0	0		
D16	VCCIO1	1			VCCIO1	1		
D21	VCCIO1	1			VCCIO1	1		
G18	VCCIO1	1			VCCIO1	1		
J15	VCCIO1	1			VCCIO1	1		
K15	VCCIO1	1			VCCIO1	1		
F23	VCCIO2	2			VCCIO2	2		
J20	VCCIO2	2			VCCIO2	2		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A2	GND	-			GND	-		
A25	GND	-			GND	-		
AA18	GND	-			GND	-		
AA24	GND	-			GND	-		
AA3	GND	-			GND	-		
AA9	GND	-			GND	-		
AD11	GND	-			GND	-		
AD16	GND	-			GND	-		
AD21	GND	-			GND	-		
AD6	GND	-			GND	-		
AE1	GND	-			GND	-		
AE26	GND	-			GND	-		
AF2	GND	-			GND	-		
AF25	GND	-			GND	-		
B1	GND	-			GND	-		
B26	GND	-			GND	-		
C11	GND	-			GND	-		
C16	GND	-			GND	-		
C21	GND	-			GND	-		
C6	GND	-			GND	-		
F18	GND	-			GND	-		
F24	GND	-			GND	-		
F3	GND	-			GND	-		
F9	GND	-			GND	-		
J13	GND	-			GND	-		
J14	GND	-			GND	-		
J21	GND	-			GND	-		
J6	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K13	GND	-			GND	-		
K14	GND	-			GND	-		
K16	GND	-			GND	-		
K17	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L16	GND	-			GND	-		
L17	GND	-			GND	-		
L24	GND	-			GND	-		
L3	GND	-			GND	-		
M13	GND	-			GND	-		
M14	GND	-			GND	-		
N10	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N14	GND	-			GND	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AD18	PB66A	4	BDQ69	T
AF18	PB66B	4	BDQ69	C
AC18	PB67A	4	BDQ69	T
AE18	PB67B	4	BDQ69	C
VCCIO	VCCIO4	4		
AG19	PB68A	4	BDQ69	T
AH19	PB68B	4	BDQ69	C
GND	GNDIO4	-		
AE19	PB69A	4	BDQS69	T
AF19	PB69B	4	BDQ69	C
AC19	PB70A	4	BDQ69	T
AD19	PB70B	4	BDQ69	C
AJ19	PB71A	4	BDQ69	T
AK19	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4		
AF20	PB72A	4	BDQ69	T
AH20	PB72B	4	BDQ69	C
AE20	PB73A	4	BDQ69	T
AG20	PB73B	4	BDQ69	C
GND	GNDIO4	-		
AD20	PB74A	4	BDQ78	T
AC20	PB74B	4	BDQ78	C
AH21	PB75A	4	BDQ78	T
AF21	PB75B	4	BDQ78	C
AJ20	PB76A	4	BDQ78	T
VCCIO	VCCIO4	4		
AK20	PB76B	4	BDQ78	C
AG21	PB77A	4	BDQ78	T
AE21	PB77B	4	BDQ78	C
AD21	PB78A	4	BDQS78	T
GND	GNDIO4	-		
AC21	PB78B	4	BDQ78	C
AD22	PB79A	4	BDQ78	T
AB21	PB79B	4	BDQ78	C
AJ21	PB80A	4	BDQ78	T
VCCIO	VCCIO4	4		
AK21	PB80B	4	BDQ78	C
GND	GNDIO4	-		
VCCIO	VCCIO4	4		
AJ25	PB87A	4	BDQS87***	T
AK24	PB87B	4	BDQ87	C
AJ24	PB88A	4	BDQ87	T
AK25	PB88B	4	BDQ87	C

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U21	CS1N***	8		
U17	CSN***	8		
U16	D0/SPIFASTN***	8		
VCCIO	VCCIO8	8		
T16	D1***	8		
T17	D2***	8		
T22	D3***	8		
GNDIO	GNDIO8	-		
R22	D4***	8		
T15	D5***	8		
R17	D6***	8		
T20	D7/SPID0***	8		
VCCIO	VCCIO8	8		
T21	DI/CSSPI0N***	8		
R21	DOUT/CSON/CSSPI1N***	8		
R20	BUSY/SISPI***	8		
R16	RLM0_PLLCAP	3		
R18	PR65B	3	RLM0_GDLLC_FB_A	C
GNDIO	GNDIO3	-		
R19	PR65A	3	RLM0_GDLLT_FB_A	T
P22	PR64B	3	RLM0_GDLLC_IN_A**	C (LVDS)*
P21	PR64A	3	RLM0_GDLLT_IN_A**	T (LVDS)*
P16	PR63B	3	RLM0_GPLL_C_IN_A**	C
VCCIO	VCCIO3	3		
P17	PR63A	3	RLM0_GPLLT_IN_A**	T
P20	PR62B	3	RLM0_GPLL_C_FB_A	C (LVDS)*
P19	PR62A	3	RLM0_GPLLT_FB_A	T (LVDS)*
GNDIO	GNDIO3	-		
VCCIO	VCCIO3	3		
P18	PR55B	3	RDQ52	C
N16	PR55A	3	RDQ52	T
GNDIO	GNDIO3	-		
N22	PR54B	3	RDQ52	C (LVDS)*
N21	PR54A	3	RDQ52	T (LVDS)*
N17	PR53B	3	RDQ52	C
N18	PR53A	3	RDQ52	T
VCCIO	VCCIO3	3		
M22	PR52B	3	RDQ52	C (LVDS)*
M21	PR52A	3	RDQS52	T (LVDS)*
M16	PR51B	3	RDQ52	C
GNDIO	GNDIO3	-		
M17	PR51A	3	RDQ52	T
M20	PR50B	3	RDQ52	C (LVDS)*

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
E13	PT28A	0		T	PT37A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
GNDIO	GNDIO0	-			GNDIO0	-			
J12	PT5B	0		C	PT31B	0		C	
GNDIO	GNDIO0	-			-	-			
VCCIO	VCCIO0	0			VCCIO0	0			
H10	PT5A	0		T	PT31A	0		T	
E12	PT4B	0		C	PT30B	0		C	
D11	PT4A	0		T	PT30A	0		T	
H11	PT3B	0		C	PT29B	0		C	
F11	PT3A	0		T	PT29A	0		T	
C13	VCC	-			ULC_SQ_VCCR0	11			
A12	PT19A	0		T	ULC_SQ_HDINP0	11		T	
B13	NC	-			ULC_SQ_VCCIB0	11			
B12	PT19B	0		C	ULC_SQ_HDINN0	11		C	
C10	VCC	-			ULC_SQ_VCCTX0	11			
A9	PT17A	0		T	ULC_SQ_HDOUTP0	11		T	
A10	NC	-			ULC_SQ_VCCOB0	11			
B9	PT17B	0		C	ULC_SQ_HDOUTN0	11		C	
C9	VCC	-			ULC_SQ_VCCTX1	11			
B8	PT18B	0		C	ULC_SQ_HDOUTN1	11		C	
C8	NC	-			ULC_SQ_VCCOB1	11			
A8	PT18A	0		T	ULC_SQ_HDOUTP1	11		T	
C12	VCC	-			ULC_SQ_VCCR1	11			
B11	PT16B	0		C	ULC_SQ_HDINN1	11		C	
C11	NC	-			ULC_SQ_VCCIB1	11			
A11	PT16A	0		T	ULC_SQ_HDINP1	11		T	
B7	VCCAUX	-			ULC_SQ_VCCAUX33	11			
E7	PT15B	0		C	ULC_SQ_REFCLKN	11		C	
D7	PT15A	0		T	ULC_SQ_REFCLKP	11		T	
C7	VCC	-			ULC_SQ_VCCP	11			
A3	PT12A	0		T	ULC_SQ_HDINP2	11		T	
C3	NC	-			ULC_SQ_VCCIB2	11			
B3	PT12B	0		C	ULC_SQ_HDINN2	11		C	
C2	VCC	-			ULC_SQ_VCCR2	11			
A6	PT14A	0		T	ULC_SQ_HDOUTP2	11		T	
C6	NC	-			ULC_SQ_VCCOB2	11			
B6	PT14B	0		C	ULC_SQ_HDOUTN2	11		C	
C5	VCC	-			ULC_SQ_VCCTX2	11			
B5	PT13B	0		C	ULC_SQ_HDOUTN3	11		C	
A4	NC	-			ULC_SQ_VCCOB3	11			
A5	PT13A	0		T	ULC_SQ_HDOUTP3	11		T	
C4	VCC	-			ULC_SQ_VCCTX3	11			
B2	PT11B	0		C	ULC_SQ_HDINN3	11		C	
B1	NC	-			ULC_SQ_VCCIB3	11			
A2	PT11A	0		T	ULC_SQ_HDINP3	11		T	
C1	VCC	-			ULC_SQ_VCCR3	11			
L12	VCC	-			VCC	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
K13	VCCIO0	0			VCCIO0	0			
D17	VCCIO1	1			VCCIO1	1			
E22	VCCIO1	1			VCCIO1	1			
E25	VCCIO1	1			VCCIO1	1			
F19	VCCIO1	1			VCCIO1	1			
K18	VCCIO1	1			VCCIO1	1			
K19	VCCIO1	1			VCCIO1	1			
F28	VCCIO2	2			VCCIO2	2			
J25	VCCIO2	2			VCCIO2	2			
K28	VCCIO2	2			VCCIO2	2			
M21	VCCIO2	2			VCCIO2	2			
M24	VCCIO2	2			VCCIO2	2			
N21	VCCIO2	2			VCCIO2	2			
N28	VCCIO2	2			VCCIO2	2			
P21	VCCIO2	2			VCCIO2	2			
R25	VCCIO2	2			VCCIO2	2			
AA28	VCCIO3	3			VCCIO3	3			
AB25	VCCIO3	3			VCCIO3	3			
AE28	VCCIO3	3			VCCIO3	3			
T25	VCCIO3	3			VCCIO3	3			
U21	VCCIO3	3			VCCIO3	3			
V21	VCCIO3	3			VCCIO3	3			
V28	VCCIO3	3			VCCIO3	3			
W21	VCCIO3	3			VCCIO3	3			
W24	VCCIO3	3			VCCIO3	3			
AA18	VCCIO4	4			VCCIO4	4			
AA19	VCCIO4	4			VCCIO4	4			
AE19	VCCIO4	4			VCCIO4	4			
AF22	VCCIO4	4			VCCIO4	4			
AG17	VCCIO4	4			VCCIO4	4			
AG25	VCCIO4	4			VCCIO4	4			
AA12	VCCIO5	5			VCCIO5	5			
AA13	VCCIO5	5			VCCIO5	5			
AE12	VCCIO5	5			VCCIO5	5			
AF9	VCCIO5	5			VCCIO5	5			
AG14	VCCIO5	5			VCCIO5	5			
AG6	VCCIO5	5			VCCIO5	5			
AA3	VCCIO6	6			VCCIO6	6			
AB6	VCCIO6	6			VCCIO6	6			
AE3	VCCIO6	6			VCCIO6	6			
T6	VCCIO6	6			VCCIO6	6			
U10	VCCIO6	6			VCCIO6	6			
V10	VCCIO6	6			VCCIO6	6			
V3	VCCIO6	6			VCCIO6	6			
W10	VCCIO6	6			VCCIO6	6			
W7	VCCIO6	6			VCCIO6	6			
F3	VCCIO7	7			VCCIO7	7			
J6	VCCIO7	7			VCCIO7	7			